

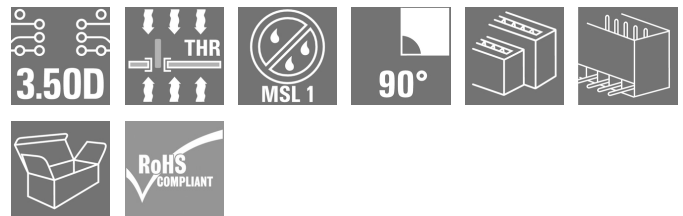
**S2CD-THR 3.50/28/90G 3.2SN BK BX****Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

**Product image****The new benchmark for component density: the virtual 0.875mm pitch - for 1mm<sup>2</sup> I/O connections**

The only 4-row double level male connectors for standard IP20 sensor interfaces with 3.5 pitch

The S2L in a double pack - a standard has surpassed itself:

- Each 3.5mm wide, 4 I/O contacts for 1mm<sup>2</sup> connection cross-section
- Force-fit enclosure geometry guarantees maximum stability
- Solder flange eliminates the need for a screw fastening

Less is more - basic advantages for your applications:

- 75% space savings on the circuit board
- Solder flange reduces process costs
- Less mechanical load on the soldering points
- More space for displays in the front panel, for example

A "small" contribution to greater competitiveness: additional features in the same installation space or a more compact device with the same range of functions.

**General ordering data**

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 28, 90°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	<a href="#">1357850000</a>
Type	S2CD-THR 3.50/28/90G 3.2SN BK BX
GTIN (EAN)	4050118160819
Qty.	20 pc(s).
Product data	IEC: 200 V / 7.9 A UL: 150 V / 9.5 A
Packaging	Box

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**Technical data****Dimensions and weights**

Depth	24.4 mm	Depth (inches)	0.961 inch
Height	35 mm	Height (inches)	1.378 inch
Height of lowest version	31.8 mm	Width	25.9 mm
Width (inches)	1.02 inch	Net weight	14.4 g

**System specifications**

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 "	Outgoing elbow	90°
Number of poles	28	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D) + 0,1 mm	
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	45.5 mm	L1 in inches	1.791 "
Number of rows	2	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged	Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged
Can be coded	Yes		

**Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...5 µm Sn matt
Layer structure of plug contact	2...5 µm Sn / 1...3 µm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

**Rated data acc. to IEC**

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	7.9 A
Rated current, max. number of poles (Tu=20°C)	5 A	Rated current, min. number of poles (Tu=40°C)	6.8 A
Rated current, max. number of poles (Tu=40°C)	5 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	100 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	1.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

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**Technical data****Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA) 50 V

Rated voltage (Use group C / CSA) 50 V

Rated voltage (Use group D / CSA) 150 V

Rated current (Use group B / CSA) 5 A

Rated current (Use group C / CSA) 9.5 A

Rated current (Use group D / CSA) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

**Rated data acc. to UL 1059**

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 150 V

Rated voltage (Use group C / UL 1059) 50 V

Rated voltage (Use group D / UL 1059) 50 V

Rated current (Use group B / UL 1059) 9.5 A

Rated current (Use group C / UL 1059) 9.5 A

Rated current (Use group D / UL 1059) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

**Packing**

Packaging

Box

VPE length

143 mm

VPE width

105 mm

VPE height

39 mm

**Classifications**

ETIM 6.0

EC002637

ETIM 7.0

EC002637

ETIM 8.0

EC002637

ETIM 9.0

EC002637

ECLASS 9.0

27-44-04-02

ECLASS 9.1

27-44-04-02

ECLASS 10.0

27-44-04-02

ECLASS 11.0

27-46-02-01

ECLASS 12.0

27-46-02-01

ECLASS 13.0

27-46-02-01

**Environmental Product Compliance**

REACH SVHC

/

RoHS Compliance Status

Compliant without exemption

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**Technical data****Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul style="list-style-type: none"> <li>• Gold-plated contact surfaces on request</li> <li>• Rated current related to rated cross-section &amp; min. No. of poles.</li> <li>• Spacing between rows: see hole layout</li> <li>• P on drawing = pitch</li> <li>• Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> <li>• In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load</li> <li>• Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months</li> </ul>

**Approvals**

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

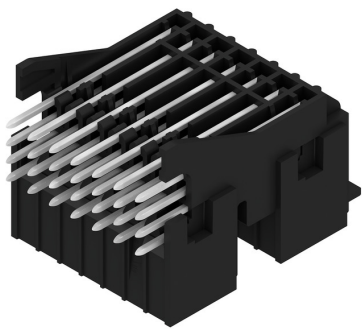
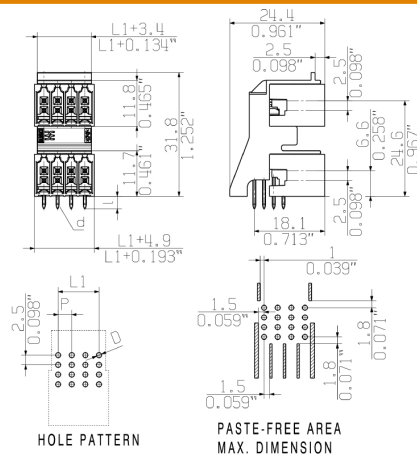
**Downloads**

Approval/Certificate/Document of Conformity	<a href="#">Declaration of the Manufacturer</a>
Engineering Data	<a href="#">CAD data – STEP</a>
Catalogues	<a href="#">Catalogues in PDF-format</a>
Brochures	<a href="#">FL DRIVES EN</a> <a href="#">MB DEVICE MANUF. EN</a> <a href="#">FL DRIVES DE</a> <a href="#">FL BUILDING SAFETY EN</a> <a href="#">FL APPL LED LIGHTING EN</a> <a href="#">FL INDUSTR.CONTROLS EN</a> <a href="#">FL MACHINE SAFETY EN</a> <a href="#">FL HEATING ELECTR EN</a> <a href="#">FL APPL INVERTER EN</a> <a href="#">FL BASE STATION EN</a> <a href="#">FL ELEVATOR EN</a> <a href="#">FL POWER SUPPLY EN</a> <a href="#">FL 72H SAMPLE SER EN</a> <a href="#">PO OMNIMATE EN</a> <a href="#">PO OMNIMATE EN</a>
White paper surface mount technology	<a href="#">Download Whitepaper</a>

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**Drawings****Product image****Dimensional drawing**

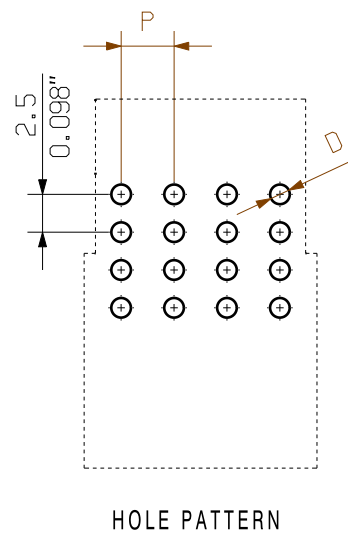
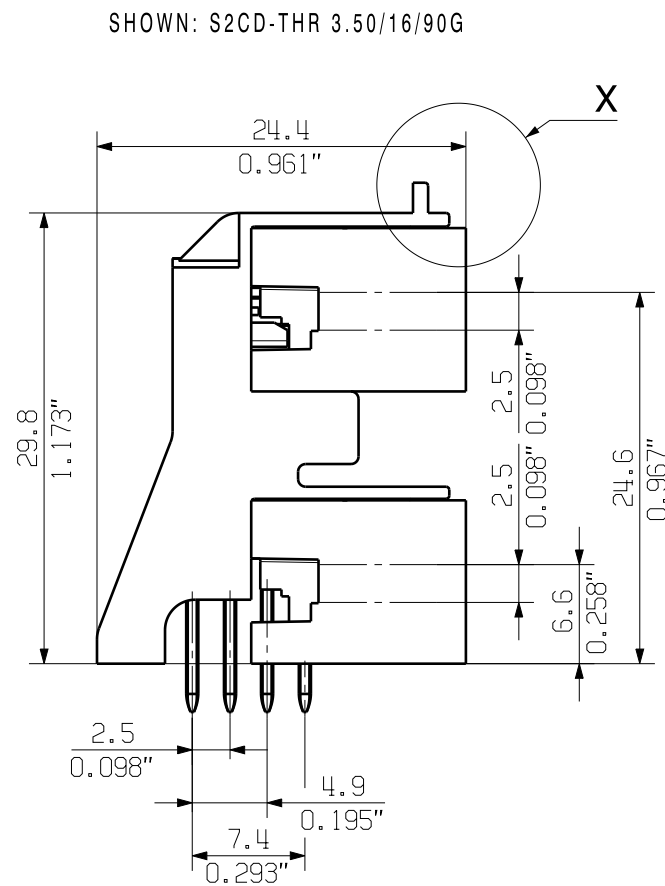
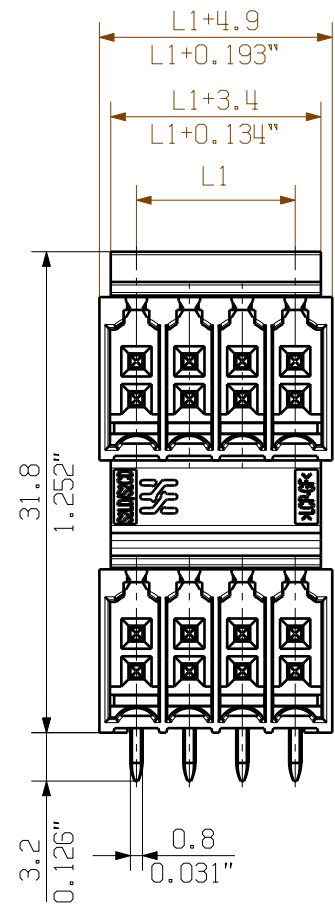
WEITERGABE SOWIE VERVIELFÄLTIGUNG DIESER DOKUMENTS, VERWERTUNG UND MITTEILUNG SEINER INHALTS SIND VERBOTEN, SOWEIT NICHT AUSDRUECKLICH GESTATTET.  
ZUWIDERHANDLUNGEN VERPFLICHTEN ZU SCHADENERSATZ. ALLE RECHTE FUER DEN FALL DER PATENT-, GEBRAUCHSMUSTER- ODER GESCHMACKSMUSTERRECHTUNG VORBEHALTEN.  
THE REPRODUCTION, DISTRIBUTION AND UTILIZATION OF THIS DOCUMENT AS WELL AS THE COMMUNICATION OF ITS CONTENTS TO OTHERS WITHOUT EXPLICIT AUTHORIZATION IS PROHIBITED.  
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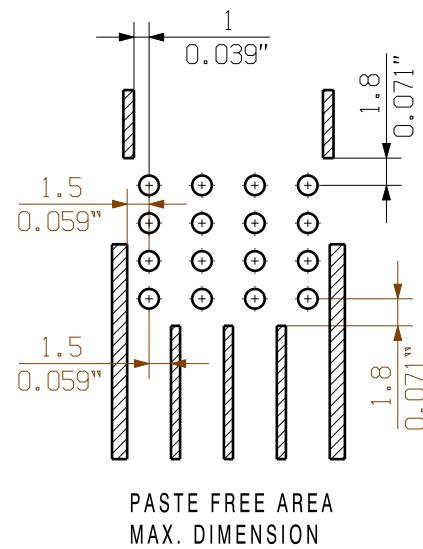
MASSE OHNE TOLERANZ SIND KEINE PRUEFMASSE  
DIMS. WITHOUT TOLERANCE ARE NOT CONTROL DIMS.

ALLGEMEINGUELTIGE KUNDENZEICHNUNG, AKTUELLER STAND NUR AUF ANFRAGE  
GENERAL CUSTOMER DRAWING, TOPICAL VERSION ONLY IF REQUIRED

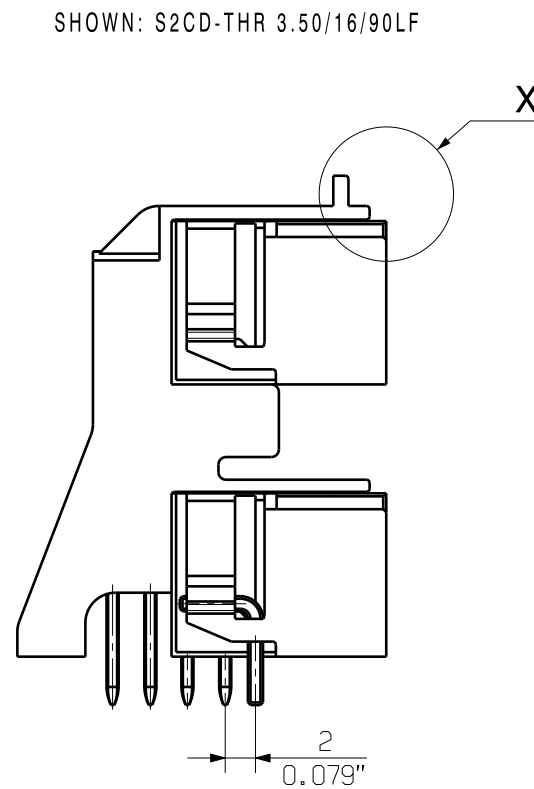
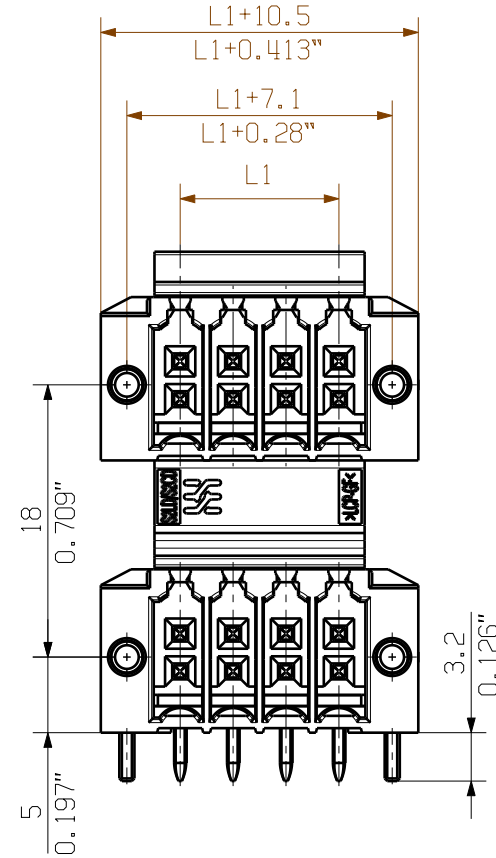
DIE DEUTSCHE VERSION IST VERBINDLICH  
THE GERMAN VERSION IS BINDING



HOLE PATTERN

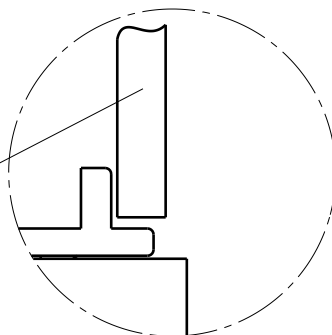


PASTE FREE AREA  
MAX. DIMENSION

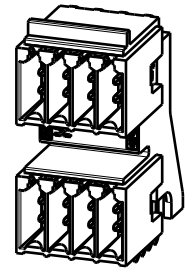


X 4/1  
ACHTUNG  
ATTENTION

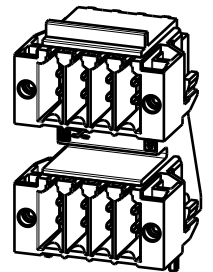
ABSTUETZUNG ERFORDERLICH  
SUPPORT NECESSARY  
BEI ALLEN VERSIONEN  
FOR ALL VERSIONS



M 1/1  
S2CD-THR 3.50/16/90G



M 1/1  
S2CD-THR 3.50/16/90LF



For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.  
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.  
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.  
Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

36	59.5	2.343
32	52.5	2.067
28	45.5	1.791
24	38.5	1.516
20	31.5	1.240
16	24.5	0.965
12	17.5	0.689
8	10.5	0.413
n	POLZAHL POLES	L1 [mm] L1 [inch]

P = 3.50 RASTER  
PITCH  
D = Ø1.3 +0.1  
0.051  
d = 0.8x0.8  
0.031"x0.031"

GENERAL TOLERANCE: DIN ISO 2768-m		74586/5 01.07.14 TIELKER_S 01		CAT.NO.: .	
RoHS COMPLIANT		MODIFICATION		Weidmüller	
DRAWN		DATE	NAME	C 55770 01	
RESPONSIBLE		31.01.2013	FRIELING_L	DRAWING NO. ISSUE NO.	
CHECKED		07.07.2014	APORIUS_S	SHEET 01 OF 01 SHEETS	
APPROVED			HELI_S_MA		
SCALE: 2/1		HANKE_D			
SUPERSEDES: .		PRODUCT FILE: B2CF/S2C		7400	
		S2CD-THR 3.50/.../90			
		STIFTELEISTE MALE HEADER			

## Recommended wave soldering profiles

**Weidmüller Interface GmbH & Co. KG**  
Klingenbergstraße 16  
D-32758 Detmold  
Germany  
Fon: +49 5231 14-0  
Fax: +49 5231 14-292083  
[www.weidmueller.com](http://www.weidmueller.com)

### Single Wave:



### Double Wave:



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

## Recommended reflow soldering profile

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Klingenbergstraße 16  
D-32758 Detmold  
Germany  
Fon: +49 5231 14-0  
Fax: +49 5231 14-292083  
www.weidmueller.com



## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.